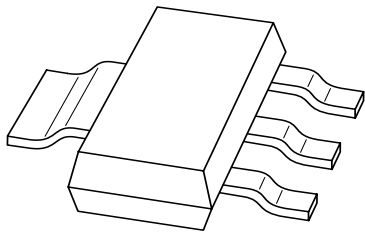


DATA SHEET



BSP19; BSP20 NPN high-voltage transistors

Product data sheet
Supersedes data of 1997 Mar 03

1999 Jun 01

NPN high-voltage transistors

BSP19; BSP20

FEATURES

- Low current (max. 100 mA)
- High voltage (max. 350 V).

APPLICATIONS

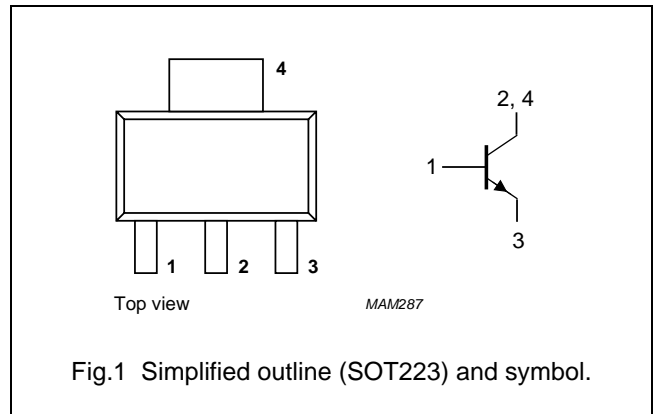
- Switching and amplification
- Especially used in telephony and automotive applications.

DESCRIPTION

NPN transistor in a SOT223 plastic package.
PNP complement: BSP16.

PINNING

| PIN | DESCRIPTION |
|------|-------------|
| 1 | base |
| 2, 4 | collector |
| 3 | emitter |



LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 134).

| SYMBOL | PARAMETER | CONDITIONS | MIN. | MAX. | UNIT |
|------------------|-------------------------------|----------------------------------|------|------|------|
| V _{CBO} | collector-base voltage | open emitter | | | |
| | BSP19 | | – | 400 | V |
| | BSP20 | | – | 300 | V |
| V _{CEO} | collector-emitter voltage | open base | | | |
| | BSP19 | | – | 350 | V |
| | BSP20 | | – | 250 | V |
| V _{EBO} | emitter-base voltage | open collector | – | 5 | V |
| I _C | collector current (DC) | | – | 100 | mA |
| I _B | base current (DC) | | – | 100 | mA |
| P _{tot} | total power dissipation | T _{amb} ≤ 25 °C; note 1 | – | 1.2 | W |
| T _{stg} | storage temperature | | –65 | +150 | °C |
| T _j | junction temperature | | – | 150 | °C |
| T _{amb} | operating ambient temperature | | –65 | +150 | °C |

Note

1. Device mounted on printed-circuit board, single sided copper, tinplated, mounting pad for collector 1 cm². For other mounting conditions, see “Thermal considerations for SOT223 in the General Part of associated Handbook”.

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THERMAL CHARACTERISTICS

| SYMBOL | PARAMETER | CONDITIONS | VALUE | UNIT |
|---------------|---|------------|-------|------|
| $R_{th\ j-a}$ | thermal resistance from junction to ambient | note 1 | 104 | K/W |
| $R_{th\ j-s}$ | thermal resistance from junction to soldering point | | 23 | K/W |

Note

1. Device mounted on printed-circuit board, single sided copper, tinned, mounting pad for collector 1 cm².
For other mounting conditions, see "Thermal considerations for SOT223 in the General Part of associated Handbook".

CHARACTERISTICS

$T_j = 25\text{ °C}$ unless otherwise specified.

| SYMBOL | PARAMETER | CONDITIONS | MIN. | MAX. | UNIT |
|-------------|--------------------------------------|--|------|------|------|
| I_{CBO} | collector cut-off current | $I_E = 0; V_{CE} = 300\text{ V}$ | – | 20 | nA |
| I_{EBO} | emitter cut-off current | $I_C = 0; V_{EB} = 5\text{ V}$ | – | 100 | nA |
| h_{FE} | DC current gain | $V_{CE} = 10\text{ V}; I_C = 20\text{ mA}$ | 40 | – | |
| V_{CEsat} | collector-emitter saturation voltage | $I_C = 50\text{ mA}; I_B = 4\text{ mA}$ | – | 0.5 | V |
| C_c | collector capacitance | $I_E = i_e = 0; V_{CB} = 10\text{ V}; f = 1\text{ MHz}$ | – | 2.5 | pF |
| f_T | transition frequency | $V_{CE} = 10\text{ V}; I_C = 10\text{ mA}; f = 100\text{ MHz}$ | 70 | – | MHz |

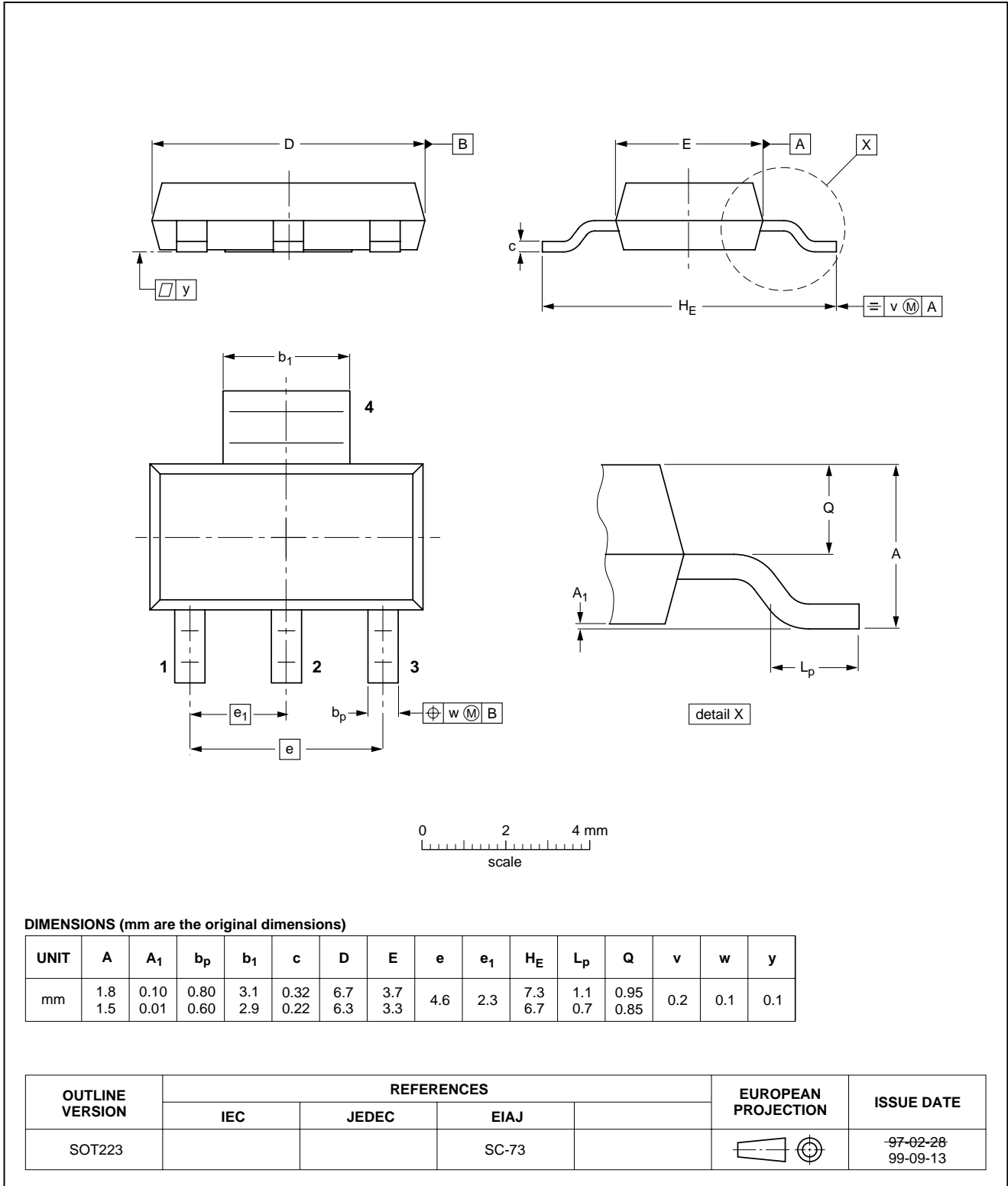
NPN high-voltage transistors

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PACKAGE OUTLINE

Plastic surface mounted package; collector pad for good heat transfer; 4 leads

SOT223



NPN high-voltage transistors

BSP19; BSP20

DATA SHEET STATUS

| DOCUMENT STATUS ⁽¹⁾ | PRODUCT STATUS ⁽²⁾ | DEFINITION |
|--------------------------------|-------------------------------|---|
| Objective data sheet | Development | This document contains data from the objective specification for product development. |
| Preliminary data sheet | Qualification | This document contains data from the preliminary specification. |
| Product data sheet | Production | This document contains the product specification. |

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Contact information

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